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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/941,760	08/30/2001		Philip J. Ireland	M4065.0143/P143-A 7179	
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WASHINGTON, DC 20037-1526				ART UNIT	PAPER NUMBER
•				1756	

DATE MAILED: 10/18/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
Office Astron Comme	09/941,760	IRELAND ET AL.					
Office Action Summary	Examiner	Art Unit					
	Nicole M Barreca	1756					
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet with the o	correspondence address					
A SHORTENED STATUTORY PERIOD FOR REF THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a relif NO period for reply is specified above, the maximum statutory perions  - Failure to reply within the set or extended period for reply will, by state than three months after the mail earned patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a reply be tirely within the statutory minimum of thirty (30) dayod will apply and will expire SIX (6) MONTHS from the cause the application to become ARADONE.	mely filed  ys will be considered timely. I the mailing date of this communication.					
Status							
1) Responsive to communication(s) filed on 02	September 2004.						
3) Since this application is in condition for allow	vance except for formal matters, pro	osecution as to the merits is					
closed in accordance with the practice under	r <i>Ex parte Quayle</i> , 1935 C.D. 11, 4	53 O.G. 213.					
Disposition of Claims							
4) Claim(s) 32.34,36-48.50.51 and 58-61 is/are	☑ Claim(s) <u>32,34,36-48,50,51 and 58-61</u> is/are pending in the application.						
	4a) Of the above claim(s) is/are withdrawn from consideration.						
5)⊠ Claim(s) <u>60</u> is/are allowed.							
6) Claim(s) 32,34,36-48,50,51,58,59 and 61 is/	are rejected.						
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and	or election requirement.						
Application Papers							
9) The specification is objected to by the Examir	ner.						
10) The drawing(s) filed on is/are: a) a		Examiner.					
Applicant may not request that any objection to th							
Replacement drawing sheet(s) including the corre							
11) The oath or declaration is objected to by the I	Examiner: Note the attached Office	Action or form PTO-152.					
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreig a) All b) Some * c) None of:	gn priority under 35 U.S.C. § 119(a)	-(d) or (f).					
1. Certified copies of the priority docume							
2. Certified copies of the priority docume							
3. Copies of the certified copies of the pri		d in this National Stage					
application from the International Bure		J					
* See the attached detailed Office action for a lis	st of the certified copies not receive	α.					
Attachment(s)  Notice of References Cited (PTO-892)	<b>"</b> □	(070, 440)					
2) Notice of References Cited (P10-892)  Provided in References Cited (P10-892)  Provided in References Cited (P10-892)	4) Interview Summary Paper No(s)/Mail Da						
B) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date	8) 5) Notice of Informal Pa	atent Application (PTO-152)					
Description Date	6) [] Other:						

#### **DETAILED ACTION**

1. Claims 32, 34, 36-48, 50, 51 and 58-61 are pending in this application.

## Claim Rejections - 35 USC § 112

- 2. The following is a quotation of the second paragraph of 35 U.S.C. 112:
  - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 3. Claims 43 and 58 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

It is unclear how claim 43 further limits claim 40. Claim 43 recites the first and second antireflective layers are formed below the insulating layer, while claim 40 previously claimed forming an insulting layer over the second antireflective and forming the second antireflective layer over the first antireflective layer.

It is unclear how a dielectric layer can be located between the first and second antireflective layers, as recited in claim 58, when claim 32 previously recited that the second layer is formed over and in contact with the first.

# Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

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- 5. Claims 32, 34, 36-38, 59 are rejected under 35 U.S.C. 102(e) as being anticipated by Blatchford (US6200734).
- Blatchford discloses a method for fabricating semiconductor devices in integrated 6. circuits using photolithography. The semiconductor device comprises substrate 10, field oxides 11 (dielectric) of varying topography, metal layer 18 (reflective), antireflection coating 17 and photoresist layer 16. The layer of metal will ultimately be patterned to gate electrodes when the MOSFET device is formed. The antireflection coating 17 comprises three layers 13-15 of silicon containing oxides such as silicon oxynitrides, each with different indices of refraction (n) and extinction coefficients or absorptions (k). The antireflection layers are used to eliminate the interference patterns caused by the rays reflected by the underlying topography when the photoresist is exposed (col.1, 18col.2, 64). When there are three antireflection layers, the first antireflection layer 13 is formed with a thickness of 350-450 angstroms (35-45 nm), while the second antireflection layer 15 is formed with a thickness between 150-250 angstroms (15-25 nm). For the first antireflection layer, k1 is between about 1.1-1.9 and for the second antireflection layer, k2 is between about 0.15-0.3. The index of refraction n2 is in the range of 1.7-2.0 (col.4, 49-61). In order to prevent crosslinking between the photoresist layer 16 and the antireflection coating 17, an additional oxynitride layer 19 (dielectric material, cl.37 or insulating layer formed over the second antireflective layer) is formed there between (col.3, 8-15).

Claim Rejections - 35 USC § 103

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7. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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- 8. Claim 39 is rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford.
- 9. Blatchford teaches that k1 is between about 1.1-1.9, k2 is between about 0.15-0.3 and n2 is in the range of 1.7-2.0 (col.4, 49-61). Blatchford also teaches that the indices of refraction for the antireflective layers are different, but is silent on the specific index of refraction for the first antireflective layer, n1, (for the embodiment where there are three antireflective layers), and does not disclose that the first index of refraction is approximately 2.1. However Blatchford teaches that the indices of refraction are varied in the three layers by varying the ratio of silane to nitrous oxide during the deposition and are designed to with used with a photoresist layer which is exposed to DUV light in order to avoid destructive interference of the reflected rays, thereby establishing the indices of refraction as result-effective variables. It would have been within the ordinary skill of one in the art to determine the optimal index of refraction for the first antireflection layer in Blatchford by routine experimentation and to have the thickness be approximately 2.1, if required, because Blatchford establishes that the index of refraction is a result-effect variable and the discovery of an optimum value of a result effective variable is ordinary within the skill of the art (In re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980)).

- 10. Claims 40-45, 47, 48 are rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford in view of Fukuda (US 6255151).
- The teachings of Blatchford have been discussed above. Blatchford teaches a 11. structure comprising three antireflection layers having different indices of refraction, a dielectric layer and a photoresist layer for patterning use in the manufacture of a semiconductor device. Blatchford however is silent on the specific semiconductor device being formed and does not disclose that the semiconductor device comprises a memory cell comprising at least two active areas, a gate stack between the active areas, and a capacitor in electrical contact with one of the active areas (cl.40), or that the structure is a DRAM cell comprising first, second and third active areas, first and second gate stacks and first and second capacitors, the first gate stack being formed between the first and second active areas, the second gate stack being formed between the second and third active areas, the first capacitor being in electrical contact with the first active area, the second capacitor being in electrical contact with the third active area, and the second active area being in electrical contact with a bit line (cl.44), or that the capacitors are formed over the gate stacks (cl.45), or that the bit line is formed over the capacitors (cl.47).

Fukuda teaches that memory cells of a DRAM are generally placed at points where a plurality of word and bit lines intersect on a principal surface of the semiconductor substrate in matrix form. Each memory cell comprises one memory cell section (MISFET) and one capacitor electrically connected in series therewith. The memory cell selection is formed within an active region, is surrounded by a device

separation region and comprises a gate oxide, a gate electrode constructed with each word line, and a source/drain pair. Each bit line is placed at an upper portion of the memory cell and is electrically connected to one of the source and drain shared by two adjacent memory cells, while the capacitor is also placed in the upper portion and electrically connected to the other of the source and drain (col.1, 14-33). It would have been obvious to one of ordinary skill in the art to have the structure comprising the semiconductor substrate, three antireflection layers, dielectric layer and photoresist layer in Blatchford to additionally include components such as active regions, gate stacks, capacitors and bit lines, arranged as claimed (cl.40, 45, 47), because Fukada teaches that such components in this arrangement are conventional for a memory cell in the art. While Fukuda does not explicitly disclose that there are three active regions that are specifically arranged as claimed in cl.44, the reference does teach that there are a plurality of memory cells and bit and word lines, arranged in series. It would have been within the ordinary skill of one in the art to determine the exact number of active regions and cells required for the specific device being manufactured because Fukuda teaches that such memory cells and their general structure are known in the art.

With respect to claim 49, Blatchford teaches that k1 is between about 1.1-1.9, k2 is between about 0.15-0.3 and n2 is in the range of 1.7-2.0 (col.4, 49-61). Blatchford also teaches that the indices of refraction for the antireflective layers are different, but is silent on the specific index of refraction for the first antireflective layer (for the embodiment where there are three antireflective layers), and does not disclose that the first index of refraction is approximately 2.1. However Blatchford teaches that the

617 F.2d 272, 205 USPQ 215 (CCPA 1980)).

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indices of refraction are varied in the three layers by varying the ratio of silane to nitrous oxide during the deposition and are designed to with used with a photoresist layer which is exposed to DUV light in order to avoid destructive interference of the reflected rays, thereby establishing the indices of refraction as result-effective variables. It would have been within the ordinary skill of one in the art to determine the optimal index of refraction for the first antireflection layer in Blatchford by routine experimentation and to have the thickness be approximately 2.1, if required, because Blatchford establishes that the index of refraction is a result-effect variable and the discovery of an optimum value of a result effective variable is ordinary within the skill of the art (*In re Boesch*,

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- 12. Claim 46 is rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford in view of Fukuda as applied to claim 45 above, and further in view of Chen (US 6140179).
- 13. While Blatchford in view of Fukuda teaches capacitors arranged in the memory cell, the references do not disclose that the capacitors are container capacitors. Chen teaches that crown (or container) capacitors conventional in the art (col.2, 23-27, col.3, 5-6). It would have been obvious to one of ordinary skill in the art to have the capacitor in Blatchford in view of Fukuda be a container capacitor because Chen teaches crown (container) capacitors are conventional in the art.
- 14. Claim 50 is rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford in view of Lyons (US 6287959) and Fukuda.

15. The teachings of Blatchford have been discussed above. Blatchford teaches a structure comprising three antireflection layers of silicon oxynitride having different indices of refraction, a dielectric layer and a photoresist layer for patterning use in the manufacture of a semiconductor device. Blatchford does not disclose that the silicon oxynitride antireflective layers are an etch stop layer. Lyons teaches that silicon oxynitride can be used as both a successful antireflective layer and etch stop (col.2, 34-41, col.4, 42-49). One of ordinary skill in the art would have to expect that the antireflective layers of silicon oxynitride in Blatchford would additionally function as an etch stop layer because Lyons teaches that that silicon oxynitride can be used as both a successful antireflective layer and etch stop.

Blatchford is silent on the specific semiconductor device being formed and does not disclose that the semiconductor device comprises a memory cell comprising at least two active areas, a gate stack between the active areas, and a capacitor in electrical contact with one of the active areas. Fukuda teaches that memory cells of a DRAM are generally placed at points where a plurality of word and bit lines intersect on a principal surface of the semiconductor substrate in matrix form. Each memory cell comprises one memory cell section (MISFET) and one capacitor electrically connected in series therewith. The memory cell selection is formed within an active region, is surrounded by a device separation region and comprises a gate oxide, a gate electrode constructed with each word line, and a source/drain pair. Each bit line is placed at an upper portion of the memory cell and is electrically connected to one of the source and drain shared by two adjacent memory cells, while the capacitor is also placed in the upper portion

and electrically connected to the other of the source and drain (col.1, 14-33). It would have been obvious to one of ordinary skill in the art to have the structure comprising the semiconductor substrate, antireflection layers, dielectric layer and photoresist layer in Blatchford in view of Lyons to additionally include components such as active regions, gate stacks, capacitors and bit lines, arranged as claimed in claim 50 because Fukada teaches that such components in this arrangement are conventional for a memory cell in the art.

- 16. Claim 51 is rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford in view of Fukada and Podlesny (US 5724299).
- 17. The teachings of Blatchford and Fukuda have been discussed above. Blatchford teaches a structure comprising three antireflection layers having different indices of refraction, a dielectric layer and a photoresist layer for use in the manufacture of a semiconductor device, while Fukuda teaches the components and arrangement of a conventional memory cell. The references however do not disclose a computer system comprising a processor and a memory comprising at one memory cell comprising the components as claimed. Podlesny teaches that a memory cell array is typically used as memory for a computer system having a processor (col.6, 42-46). It would have been obvious to one of ordinary skill in the art to have the memory cell including the multiple antireflective layers in Blatchford in view of Fukuda as the memory, along with a processor, in order to form a computer system because Podlesny teaches that it is known in the art to use a memory cell array as memory for a computer system having a processor.

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18. Claim 61 is rejected under 35 U.S.C. 103(a) as being unpatentable over Blatchford in view of Lyons.

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19. The teachings of Blatchford have been discussed above. Blatchford teaches a structure comprising three antireflection layers having different indices of refraction, a dielectric layer and a photoresist layer for patterning use in the manufacture of a semiconductor device. Blatchford does not disclose that the silicon oxynitride antireflective layers are an etch stop layer. Lyons teaches that silicon oxynitride can be used as both a successful antireflective layer and etch stop (col.2, 34-41, col.4, 42-49). One of ordinary skill in the art would have to expect that the antireflective layers of silicon oxynitride in Blatchford would additionally function as an etch stop layer because Lyons teaches that that silicon oxynitride can be used as both a successful antireflective layer and etch stop.

### Allowable Subject Matter

- 20. Claim 60 is allowed.
- 21. The following is a statement of reasons for the indication of allowable subject matter: the prior art fails to teach or suggest an integrated circuit comprising a first silicon dioxide formed over a reflective surface, a first antireflective layer formed over and in contact with the first silicon dioxide, a second antireflective layer formed over and in contact with the first antireflective layer and a second dioxide layer formed over the second antireflective layer.

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### Response to Arguments

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- 22. Applicant's arguments filed 9/2/04 have been fully considered but they are not persuasive.
- 23. The applicant argues that Blatchford does not teach a first and second antireflective coating layer. However the reference clearly teaches three antireflective layers 13, 14 and 15, corresponding to the applicant's first, second and additional (cl.36) antireflective layers. The applicant also argues that Blatchford does not disclose that the reflected radiation mutually cancels when combined. However Blatchford does teach that the radiation is mutually canceled when the reference discloses that the antireflection layers are used to eliminate the interference patterns caused by the rays reflected by the underlying topography when the photoresist is exposed (col.1, 18-col.2, 64). In addition that limitation and the limitation reciting how the indices of refraction, absorptions and thicknesses are chosen are process limitations which do not further limit the product claims.
- 24. The applicant's argument regarding claim 61 is moot in view of the new grounds of rejection.
- 25. With respect to claim 39 the applicant argues that it would not have been obvious for one of ordinary skill in the art to determine the first index of refraction of 2.1 because the Office Action fails to establish the three requirements for a *prima facie* case of obviousness. First, Blatchford teaches that the indices of refraction are varied in the three layers by varying the ratio of silane to nitrous oxide during the deposition and are designed to with used with a photoresist layer which is exposed to DUV light in order to

avoid destructive interference of the reflected rays, thereby establishing the indices of refraction as result-effective variables. This in combination with the teachings of *In re Boesch* (i.e. the discovery of an optimum value of a result effective variable is ordinary within the skill of the art) provides the motivation. Second, there is a reasonable expectation of success since Blatchford does teach all other claimed variables. It does not seem unreasonable for one of ordinary skill in the art to determine one index of refraction when all other variables (n, k and thickness) are taught by Blatchford. Third, all claim limitations are taught by the combination of the teachings of Blatchford and *In re Boesch*. (If Blatchford taught all claim limitations it would have been a 102, not a 103 rejection.)

26. With respect to claims 40-48, in response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, the motivation can be found in the references. Blatchford teaches a patterning method for making a general semiconductor device. One of ordinary skill in the art would recognize that once the patterns are formed using photolithography, that any specific semiconductor device could be produced using the teachings of Fukuda and Chen, which teach the known required components of the specifically desired devices.

#### Conclusion

27. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Nicole M Barreca whose telephone number is 571-272-1379. The examiner can normally be reached on Monday-Thursday (9AM-7PM).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark Huff can be reached on 571-272-1385. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Nicole M Barreca Examiner Art Unit 1756

Micole Manne

10/7/04